Accelerating the Possibilities with HPC

Trish Damkroger
Vice President and General Manager, High Performance Computing
HPC is Evolving, Expanding and Everywhere

More use cases
+ More data
+ More users
= New requirements
Intel® HPC Portfolio

**XPU Architectures**
Compute + Acceleration

**Software Tools**
oneAPI • HPC & AI Analytics Toolkit

**Memory**
Optane™ Persistent Memory

**Storage**
- Optane™ SSDs
- DAOS

**Interconnect**
- Ethernet
- Fabric support

**Security**
- Crypto Acceleration
- Intel® SGX
Intel® HPC Portfolio

XPU Architectures
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NEW
DAOS Commercial Support

NEW
High Performance Networking
3rd Gen Intel® Xeon® Scalable processors

- **Up to 6TB**
  System Memory Capacity (Per Socket) DRAM + PMEM

- **Up to 8CH**
  DDR4-3200 2 DPC (Per Socket)

- **Up to 40 Cores**
  per processor

- 20% IPC improvement
  ISO Freq, ISO compiler

- **53%**
  Increase for HPC workloads*

**Advanced security solutions**

- Intel Software Guard Extensions
- Intel Crypto Acceleration
- Intel Total Memory Encryption
- Intel Platform Firmware Resilience

**Scalable, flexible, customizable**

- Intel Deep Learning Boost
- Intel Speed Select Technology
- Intel AVX-512
- oneAPI
- Optimized Software

*See [108] at www.intel.com/3gen-xeon-config. Results may vary. See backup for configuration details.
Competitive Leadership

<table>
<thead>
<tr>
<th>Application</th>
<th>Intel Xeon 8358</th>
<th>AMD EPYC Milan 7543</th>
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<tr>
<td>Monte Carlo</td>
<td>Up to 105%</td>
<td>Up to 62%</td>
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<tr>
<td>RELION</td>
<td>Up to 68%</td>
<td></td>
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<tr>
<td>LAMMPS</td>
<td>Up to 57%</td>
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<tr>
<td>NAMD</td>
<td>Up to 62%</td>
<td>Up to 37%</td>
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<td>Binomial Options</td>
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Mainstream SKUs: Intel Xeon 8358 vs EPYC Milan 7543

See backup for configuration details. Results may vary.
Software Optimized Performance
End-to-End Workload Optimization via oneAPI

Leadership AI Performance
End-to-End Workload Optimization via oneAPI

33.1 Sec

20.7% Speed Up

27.4 Sec

AMD EPYC™ 'Milan' 7763 (64C)

3rd Gen Xeon® Scalable 8380 (40C)

*Performance varies by use, configuration and other factors. See [56] at www.intel.com/3gen-xeon-config.
Welcoming Ice Lake customers and partners
3rd Gen Intel® Xeon® Scalable processor momentum
Xe Architecture: Brought to Life

- $X^e_{HPC}$: Powered On & In Validation
- $X^e_{HP}$: In Intel® DevCloud
- $X^e_{HPG}$: DG2 Sampling
- $X^e_{LP}$: 11th Gen Core Processor, Iris Xe MAX, Intel® Server GPU

- Terra flops – peta ops
- Ponte Vecchio
- OAM
- x4 Sub-System
Freedom for Accelerated Compute
Break Free from the Constraints of Proprietary Programming Models

Freedom of Choice in Hardware
Multi-Vendor Adoption Momentum
- Codeplay brings SYCL support for NVIDIA GPUs
- Fujitsu Fugaku uses oneAPI oneDNN on Arm
- Huawei AI Chipset supported by Data Parallel C++
- NERSC, ALCF, Codeplay partner on SYCL for next gen Supercomputer

Realize All the Hardware Value on XPU
Optimized Libraries, Compilers, AnalysisTools & Intel® DevCloud

Confidently Develop Performant Code
Compatible with Existing Languages & Standards
Intel® oneAPI Toolkits for HPC, AI, Rendering...
"We see Intel as a vital long-term partner at Cambridge, investing in our community through systems development, training, and access to new and emerging technologies.

[At] the Cambridge Open Exascale Lab... users can access our 10 petaflop system to develop code for Intel GPUs using oneAPI and get help optimizing applications for both CPUs and accelerators. They can also investigate into extreme scale storage systems like Intel DAOS and work with cutting-edge high-performance Ethernet fabrics."

**Dr. Paul Calleja**
Director of Research Computing Services
University of Cambridge
"Intel is providing the blended environment we need, with next-generation Intel Xeon Scalable processors (Sapphire Rapids), with built-in acceleration for new HPC and AI workloads—plus Ponte Vecchio, Intel’s upcoming GPU.

Since our users need to access data as quickly as possible, we’ll be using Intel DAOS for fast, high bandwidth, low latency, and high IOPS storage, on a system with 3rd Gen Xeon processors and Optane persistent memory."

Prof. Dieter Kranzlmüller
Chairman of the Board of Directors of the Leibniz Supercomputing Centre (LRZ)
Intel® Xeon® Scalable Processor
The ONLY x86 Datacenter CPU with Built-in AI Acceleration

Intel® Advanced Vector Extensions 512
Intel® Deep Learning Boost
Intel® Optane™ persistent memory

Cascade Lake
14nm
New AI acceleration built-in
(Intel® DL Boost with VNNI)
New memory storage hierarchy

Ice Lake
10nm
New microarchitecture
Increased memory bandwidth

Sapphire Rapids
10nm Enhanced SuperFin
Next gen Intel® DL Boost
(Intel® Advanced Matrix Extensions)

Accelerating Innovation
from Edge to Cloud to Supercomputing
Next-Generation Intel Xeon Scalable Processors
Unique Capabilities Optimized for HPC and AI Acceleration
Next-Generation Intel Xeon Scalable Processors
Unique Capabilities Optimized for HPC and AI Acceleration

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<tr>
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<th>DDR5</th>
<th>PCIE 5</th>
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Next-Generation Intel Xeon Scalable Processors
Unique Capabilities Optimized for HPC and AI Acceleration

Breakthrough Technology
- DDR5
  - Increased Memory BW
- PCIE 5
  - High Throughput
- CXL 1.1
  - Next-gen IO

Built-In AI Acceleration
- Intel® Advanced Matrix Extensions (AMX)
  - Increased Deep Learning Inference and Training Performance
Next-Generation Intel Xeon Scalable Processors
Unique Capabilities Optimized for HPC and AI Acceleration

Breakthrough Technology
- DDR5: Increased Memory BW
- PCIe 5: High Throughput
- CXL 1.1: Next-gen IO

Built-In AI Acceleration
- Intel® Advanced Matrix Extensions (AMX): Increased Deep Learning Inference and Training Performance

Agility and Scalability
- Hardware Enhanced Security
- Intel® Speed Select Technology
- Broad Software Optimization
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- Intel® Advanced Matrix Extensions (AMX): Increased Deep Learning Inference and Training Performance

Agility and Scalability
- Hardware Enhanced Security
- Intel® Speed Select Technology
- Broad Software Optimization

High Bandwidth Memory
- Significant performance increase for bandwidth-bound workloads
Accelerating HPC for the Future

Intel Xeon processors remain the foundation of HPC & AI
Accelerating HPC for the Future

Intel Xeon processors remain the foundation of HPC & AI

Intel delivers heterogeneous architectures for today’s & tomorrow’s challenges
Accelerating HPC for the Future

Intel Xeon processors remain the foundation of HPC & AI

Intel delivers heterogeneous architectures for today’s & tomorrow’s challenges

Intel’s HPC portfolio has the flexibility to grow with changing customer demands
Fireside Chats

Purpose-Built AI Accelerators Deployment for High Performance Computing

HPC in the Cloud: Extending the Reach and Impact of HPC for Everyone

Standards Driven Heterogenous Programming with oneAPI

Cornelis Networks Omni-Path Express™ (OPX) Technology: Purpose Built, High Performance Fabrics in a Converged HPC/AI World

Intel and Google on Bringing DAOS to the Cloud

CXL Fireside Chat

Fireside Chat Intel System Server D50TNP for HPC

A Look Inside the Powerful HPC Partnership Between HPE and Intel and How the Joint Solutions Overcome Computing Challenges of Today’s Digital World

Considerations for HPC and AI in the Cloud

Leadership in Uncertain Times: Observations & Learnings from Industry Leaders

Technical Talks

HPC Productivity Increase with Hybrid HPCaaS

XPU Support for the NAMD Molecular Dynamics Application with oneAPI

Migrating and Tuning a CUDA-Based Stencil Computation to DPC++

Utilizing the oneAPI Rendering Toolkit to Enhance Scientific Discovery

Ice Lake, Together with Mellanox Interconnect Solutions, Deliver Best in Class Performance for HPC Applications

Optimizing a Memory-Intensive Simulation Code for Heterogenous Optane Memory Systems

Intel Quantum Computing: An Example of Workload-Driven System Design

Best Practices in Selection of the Latest Intel Technologies for HPC-Enabled Simulations

Accelerating Derivative Valuations Using AI and AVX-512

Atos to Address Exascale Challenges by Leveraging oneAPI Industry Standard to Get Ready for Intel’s Future GPUs and Next Gen Xeon Scalable Processors

A Partnership for Future HPC Technologies Exploration

Accelerate High Performance Computing on the Cloud

Visit the Intel HPC+AI Pavilion @ www.hpcevents.intel.com
**Configuration Details: Intel Xeon 8358 vs AMD EPYC 7543**

*slide 1 of 2*

HPCG: Intel Xeon 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.11.e18_3.686_64, lv Intel_SSDSC2K9G6, App Version: 2019u5 MKL; Build notes: Tools: Intel MKL 2020u4, Intel C Compiler 2020u4, Intel MPI 2019u8; threads/core: 1; Turbo: used; Build knobs: -O3 -ip -xCORE-AVX512. EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa00119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: 2019u5 MKL; Build notes: Tools: Intel MKL 2020u4, Intel C Compiler 2020u4, Intel MPI 2019u8; threads/core: 1; Turbo: used; Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021.

HPL: Intel Xeon 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.11.e18_3.686_64, lv Intel_SSDSC2K9G6, App Version: The Intel Distribution for LINPACK Benchmark; Build notes: Tools: Intel MPI 2019u7; threads/core: 1; Turbo: used; Build: build script from Intel Distribution for LINPACK package; 1 rank per NUMA node: 1 rank per socket; EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa00119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: AMD official HPL 2.3 MT version with BLIS 2.1; Build notes: Tools: hpc-x 2.7.0; threads/core: 1; Turbo: used; Build: pre-built binary (gcc built) from https://developer.amd.com/amd-aocl/blas-library/; 1 rank per L3 cache, 4 threads per rank, tested by Intel and results as of April 2021.

Stream Triad: Intel Xeon 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.11.e18_3.686_64, lv Intel_SSDSC2K9G6, App Version: McCalpin_STREAM_OMP-version; Build notes: Tools: Intel C Compiler 2019u5; threads/core: 1; Turbo: used; BIOS settings: HT=on Turbo=On SNC=On; EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa00119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: McCalpin_STREAM_OMP-version; Build notes: Tools: Intel C Compiler 2019u5; threads/core: 1; Turbo: used; BIOS settings: HT=on Turbo=On SNC=On; tested by Intel and results as of April 2021.

WRF Geomean of Conus-12km, Conus-2.5km, NWSC-3 NA-3km: Intel Xeon 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.11.e18_3.686_64, lv Intel_SSDSC2K9G6, App Version: 4.2.2; Build notes: Intel Fortran Compiler 2020u4, Intel MPI 2020u4; threads/core: 1; Turbo: used; Build knobs: -ip -w -O3 -xCORE-AVX2 -vec-threshold0 -ftz -align array64byte -qno-opt-dynamic-align -fno-alias $(FORMAT_FREE) $(BYTESWAPIO) -fp-model fast=2 -fimf-use-svml=true -fimf-model fast2 -fimf-use-svml=true -inline-max-size=12000 -inline-max-total-size=30000. EPYC 7763: 1-node, 2-socket AMD EPYC 7763 (32C/3.2GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa00119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: 4.2.2; Build notes: Intel Fortran Compiler 2020u4, Intel MPI 2020u4; threads/core: 1; Turbo: used; Build knobs: -ip -w -O3 -march=core-avx2 -vec-threshold0 -ftz -align array64byte -qno-opt-dynamic-align -fno-alias $(FORMAT_FREE) $(BYTESWAPIO) -fp-model fast2 -fimf-use-svml=true -fimf-model fast2 -fimf-use-svml=true -inline-max-size=12000 -inline-max-total-size=30000, tested by Intel and results as of April 2021.

Binomial Options: Intel Xeon 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.11.e18_3.686_64, lv Intel_SSDSC2K9G6, App Version: v1.0; Build notes: Tools: Intel Compiler 2020u4, Intel Threading Building Blocks; threads/core: 2; Turbo: used; Build knobs: -O3 -ip -XCORE-AVX512 -opt-zmm-usage=high -fimf-domain-exclusion=31 -fimf-accuracy-bits=11 -no-prec-div -no-prec-sqrt; Intel and results as of April 2021.

Configuration Details: Intel Xeon 8358 vs AMD EPYC 7543

(slide 2 of 2)

Ansys Fluent Geomean of aircraft_wing_14m, aircraft_wing_2m, combustor_12m, combustor_16m, combustor_7m, exhaust_system_33m, fluidized_bed_2m, ice_2m, landing_gear_15m, oil_ring_7m, pump_2m, rotor_3m, sedan_4m: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: 2020.1: Build notes: One thread per core; Multi-threading Enabled, Intel Turbo Boost Enabled; Intel FORTRAN Compiler 19.5.0; Intel C/C++ Compiler 19.5.0; Intel Math Kernel Library 2020.0.0; Intel MPI Library 2019 Update 8, tested by Intel and results as of April 2021

Ansys LS-DYNA Geomean of car2car-120ms, ODB_10M-30ms: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: 2020.1: Build notes: Tools: Intel Compiler 2019u5, Intel AVX2, Intel MPI 2019u9; threads/core: 1; Turbo used; Build knobs: -O3 -ip -xCORE-AVX512 -qopt-report=5 –restrict EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa001119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: 2021R1: Build notes: One thread per core; Multi-threading Enabled; Turbo Boost Enabled; Intel FORTRAN Compiler 19.5.0; Intel C/C++ Compiler 19.5.0; Intel Math Kernel Library 2020.0.0; Intel MPI Library 2019 Update 8, tested by Intel and results as of April 2021

OpenFOAM 4.2MCellMotorbike: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: v8: Build notes: Tools: Intel FORTRAN Compiler 2020u4, Intel C Compiler 2020u4, Intel MPI 2019u8; threads/core: 1; Turbo used: Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021

LAMMPS Geomean of Polyethylene, Stillinger-Weber, Tersoff, Water: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: v8: Build notes: Tools: Intel FORTRAN Compiler 2020u4, Intel C Compiler 2020u4, Intel MPI 2019u8; threads/core: 1; Turbo used: Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021

NAMD Geomean of Apoa1, STMV: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: v8: Build notes: Tools: Intel FORTRAN Compiler 2020u4, Intel C Compiler 2020u4, Intel MPI 2019u8; Intel Threading Building Blocks 2020u4, Intel MPI 2019u8; threads/core: 1; Turbo used: Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021

RELION Plasmodium Ribosome: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: 3_1_1: Build notes: Tools: Intel Compiler 2020u4, Intel MPI 2019u9; threads/core: 2; Turbo used: Build knobs: -O3 -ip -g -debug inline-debug-info -xCOMMON-AVX512 -qopt-report=5 –restrict EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa001119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: 3_1_1: Build notes: Tools: Intel Compiler 2020u4, Intel MPI 2019u9; threads/core: 2; Turbo used: Build knobs: -O3 -ip -g -debug inline-debug-info -march=core-avx2 -qopt-report=5 –restrict EPYC 7543: 1-node, 2-socket AMD EPYC 7543 (32C/2.8GHz, 240W cTDP) on Dell PowerEdge R7525 server with 1024 GB (16 slots/64GB/3200) total DDR4 memory, ucode 0xa001119, SMT on, Boost on, Power deterministic mode, NPS=4, Red Hat Enterprise Linux 8.3, 4.18, 2x Micron 5300 Pro, App Version: 3_1_1: Build notes: Tools: Intel Compiler 2020u4, Intel MPI 2019u9; threads/core: 2; Turbo used: Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021

NAMD Geomean of Apoa1, STMV: Platinum 8358: 1-node, 2x Intel® Xeon® Platinum 8358 (32C/2.6GHz, 250W TDP) processor on Intel Software Development Platform with 256 GB (16 slots/16GB/3200) total DDR4 memory, ucode 0x261, HT on, Turbo on, CentOS Linux 8.3.2011, 4.18.0-240.1.168_3.32t68_64, x1 Intel® SSDDC2KG96, App Version: 215-Alpha (includes AVX tiles algorithm); Build notes: Tools: Intel MKL, Intel C Compiler 2020u4, Intel Compiler 2020u4, Intel Threading Building Blocks 2020u4, Intel MPI 2019u8; threads/core: 2; Turbo used: Build knobs: -O3 -ip -march=core-avx2, tested by Intel and results as of April 2021

Ansys Fluent Geomean of aircraft_wing_14m, aircraft_wing_2m, combus...
End-to-End Census Workload performance (Stock):

End-to-End Census Workload performance (Optimized):

End-to-End Census Workload performance (Intel 8380 vs AMD 7763):
Tested by Intel as of 3/15/2021. Hardware configuration for Intel® Xeon® Platinum 8380: 1-node, 2x Intel Xeon Platinum 8380 (40C/2.3GHz, 270W TDP) processor on Intel Software Development Platform with 512 GB (16 slots/ 32GB/ 3200) total DDR4 memory, ucode X55260, HT on, Turbo on, RedHat Enterprize Linux 8.2, 4.18.0-193.28.1.el8_2.x86_64, 2x Intel_SSDSC2KG019T8. Tested by Intel as of 5/11/2021. Hardware configuration for AMD: AMD EPYC Milan 7763: 1-node, 2x 7763 processor (64 cores/socket, 2 threads/core), HT ON, Turbo ON, NPS=2, 4.18.0-240.el8.x86_64 with 1024 GB DDR4 memory (16 slots/32GB/3200 MHz), ucode 0xa001119, Red Hat Enterprise Linux 8.3 (Ootpa), 4.18.0-240.el8.x86_64, 2x INTEL SSDSC2KG019T8. Software : Python 3.7.9, Pre-processing Modin 0.8.3, Omniscidbe v5.4.1, Intel Optimized Scikit-Learn 0.24.1, OneDAL Daal4py 2021.2, XGBoost 1.3.3, Dataset source : IPUMS USA: https://usa.ipums.org/usa/, Dataset (size, shape) : (21721922, 45), Datatypes int64 and float64, Dataset size on disk 362.07 MB, Dataset format .csv.gz, Accuracy metric MSE: mean squared error; COD: coefficient of determination, tested by Intel, and results as of March 2021. Results may vary.
Configuration Details (20% IPC Increase)

20% IPC improvement: 3rd Gen Xeon Scalable processor: 1-node, 2x 28-core 3rd Gen Intel Xeon Scalable processor, Wilson City platform, 512GB (16 slots / 32GB / 3200) total DDR4 memory, HT on, ucode=x270, RHEL 8.0, Kernel Version4.18.0-80.el8.x86_64, test by Intel on 3/30/2021. 2nd Gen Intel Xeon Scalable processor: 1-node, 2x 28-core 2nd Gen Intel Xeon Scalable processor, Neon City platform, 384GB (12 slots / 32GB / 2933) total DDR4 memory, HT on, ucode=x2f00, RHEL 8.0, Kernel Version4.18.0-80.el8.x86_64, test by Intel on 3/30/2021. SPECrate2017_int_base (est). Tests at equal core frequency, equal uncore frequency, equal compiler.